



NOTES:

- (1) 2 Layer Board with 0,6mm thickness.
- (2) Minimum clearance = 0,15mm
- (3) Minimum track width = 0,15mm
- (4) Vias drill minimum diameter = 0,25mm and overall minimum diameter = 0,5mm

LAYER STACK UP

Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0.010mm	3.5	
1	TOP	CF-004	0.035mm		
	Dielectric1	Core-042	0.500mm	4.8	
2	BOTTOM	CF-004	0.035mm		
	Bottom Solder	Solder Resist	0.010mm	3.5	
	Bottom Overlay				

Total board thickness: 0.590mm

LAYERS REPERSENTATION

- .gbr Top Overlay
- .gbr Top Paste
- .gbr Top Solder
- .gbr TOP
- .gbr BOTTOM
- .gbr Bottom Solder
- .gbr Bottom Paste
- .gbr Bottom Overlay
- .gbr BoardOutline
- .gbr ManufacturingNotes
- .gbr Top Assembly
- .gbr Bottom Assembly
- .gbr Keep-Out Layer
- .gbr Top Pad Master
- .gbr Bottom Pad Master
- .gbr Drill Drawing
- .gbr Drill Guide
- .gbr Profile

Board Stack Report